ZETTLER DISPLAYS

SPECIFICATIONS FOR LIQUID CRYSTAL DISPLAY

	CUSTOMER A	APPROVAL	
※ PART	NO.: ATM0458D1 (ZI	ETTLER DISPL	AYS) SPEC VER1.1
APPROVAL		COMPANY CHOP	
CUSTOMER			
COMMENTS			

ZETTLER DISPLAYS ENGINEERING APPROVAL							
DESIGNED BY CHECKED BY APPROVED BY							
XW	GZC	GuZH					

REVISION RECORD

REVISION	REVISION DATE	PAGE	CONTENTS
VER1.0	2023-03-27	-	FIRST ISSUE
VER1.1	2024-12-05	16,17	UPDATE PRECAUTION

***** CONTENTS

- 1. GENERAL SPECIFICATIONS
- 2. PIN ASSIGNMENT
- 3. OPERATING SPECIFICATIONS
- 4. OPTICAL SPECIFICATIONS
- 5. RELIABILITY TEST
- 6. PRECAUTION FOR USING LCM
- 7. MECHANICAL DRAWING
- 8. PACKAGE DRAWING
- 9. INSPECTION SPECIFICATION

1. GENERAL SPECIFICATIONS

Item	Specification	Remark
1. LCD size	4.58 inch(Diagonal)	
2. Driver element	a-Si TFT active matrix	
3. Resolution	320(RGB)x960	
4. Display mode	Normally Black, IPS, Transmissive	
5. Dot Pitch (W*H)	0.0383mm(W) x 0.1149mm(H)	
6. Pixel pitch(W*H)	0.1149mm(W) x 0.1149mm(H)	
7. Active Area(W*H)	36.768mm(W) x 110.304mm(H)	
8. Module size (W*H)	41.57mm(W) x 118.8(H) x 2.5mm(D)	Note 1
Surface treatment	Anti-glare	
10. Color arrangement	RGB-stripe	
11. Color	16.7M	
12. Viewing angle (L/R/T/B)	80/80/80	
13. Interface	18bit RGB interface	
14. LCD controller	ST7701S	
15. LCM brightness	450 cd/m2 Typ.	
16. Backlight driving condition	40mA @12.0V	
17. Touch panel	w/o	
18. Touch controller	w/o	
19. Operation temperature	-20~70 °C	_
20. Weight	26g(Typ.)	
21. RoHS	RoHS compliant	

Note 1: Please refer to mechanical drawing.

2. PIN ASSIGNMENT

TFT LCD Panel Driving Section

FPC Connector is used for the module electronics interface.

The recommended model is "FH26W-39S-0.3SHW(60)" manufactured by Hirose or other compatible connectors

Pin No.	Symbol	Function	Level	Note
1	LEDA	Backlight anode	Р	
2	LEDK	Backlight cathode	Р	
3	VDD	Power supply, typical 2.8V	Р	
4~6	NC	No connect		
7	RESET	Global reset pin	I	
8	CS	Chip select	I	
9	SCL	Serial clock input for SPI interface.	I	
10~11	NC	No connect		
12	VSYNC	Vertical sync input	I	
13	HSYNC	Horizontal sync input	I	
14	ENABLE	Data enable	I	
15	DCLK	Dot clock signal for RGB interface operation	I	
16	SDA	Serial data input pin for SPI Interface	I	
17~34	DB0~DB17	parallel data bus for RGB Interface D[17:12]=R,D[11:6]=G,D[5:0]=B	I/O	
35~38	NC	No connect		
39	GND	Ground	Р	

I: input, O: output, P: Power

3. Operating Specification

3.1.1 ABSOLUTE MAXIMUM RATINGS

ltem	Symbol			Unit	Remark	
	Symbol	Min.	Max.	Oilit	Kemark	
Power Voltage	V_{DD}	-0.3	4.6	V		
Operation Temperature	T _{OP}	-20	70	°C		
Storage Temperature	T _{ST}	-30	80	°C		
LED Reverse Voltage	V _R	-	1.2	V	Each LED Note 2	
LED Forward Current	I _F		25	mA	Each LED	

Note 1: The absolute maximum rating values of this product are not allowed to be exceeded at any times. Should a module be used with any of the absolute maximum ratings exceeded, the characteristics of the module may not be recovered, or in an extreme case, the module may be permanently destroyed.

Note 2: V_R Conditions: Zener Diode 20mA

3.1.2 Typical Operation Conditions

Item	Symbol	Values				Remark	
item	Symbol	Min.	Тур.	Max.	Unit	Remark	
Power Voltage	V_{DD}	2.5	2.8	3.6	V	Note 1	
Input Logic High Voltage	V _{IH}	0.7V _{DD}		V_{DD}	V	Note 2	
Input Logic Low Voltage	V _{IL}	GND		$0.3V_{DD}$	V	Note 2	

Note 1: V_{DD} setting should match the signals output voltage of customer's system board.

Note 2: DCLK,HS,VS,RESET,DE,R0~R5,G0~G5,B0~B5,.

3.1.3 Backlight driving conditions

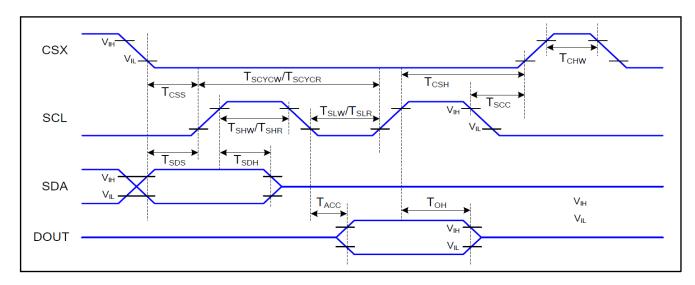
Item	Symbol	Values				Remark
item	Syllibol	Min.	Тур.	Max.	Unit	Remark
Voltage for LED Backlight	V _L	10.8	12.0	12.8	V	Note 1
Current for LED Backlight	I _L		40		mA	
LED life time		20000			Н	Note 2

Note 1: The LED Supply Voltage is defined by the number of LED at Ta=25[°]C and I_L =40mA.

Note 2: The "LED life time" is defined as the module brightness decrease to 50% original brightness at Ta=25 $^{\circ}$ C and I_L =40mA.

3.2 Timing Characteristics

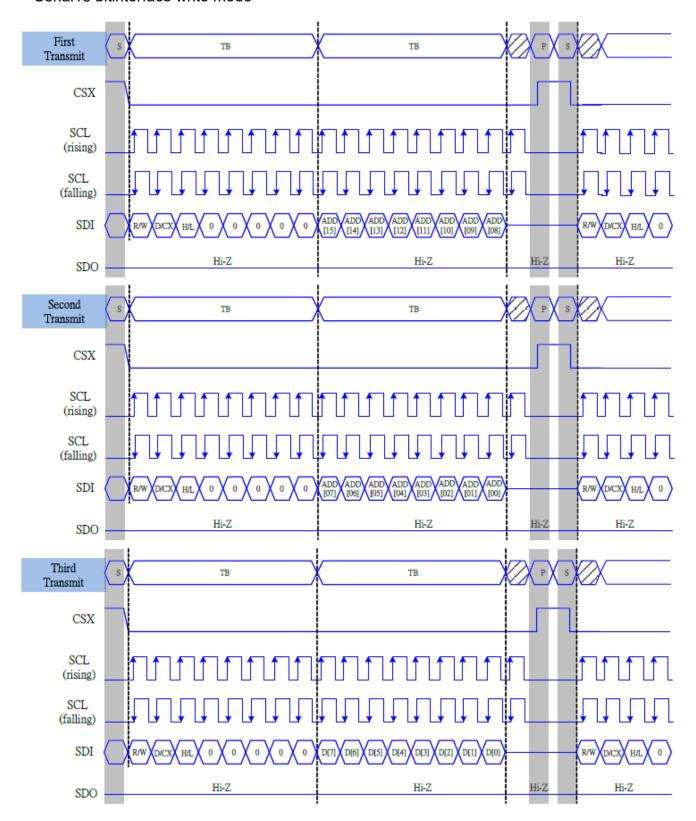
Serial Interface Characteristics (3-line serial):



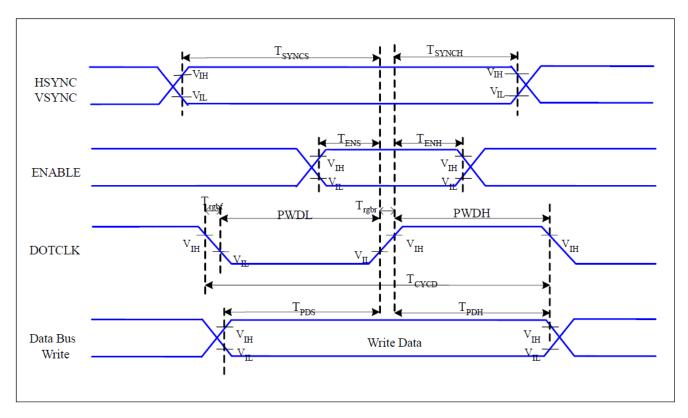
Signal	Symbol	Parameter	Min	Max	Unit	Description
	Tcss	Chip select setup time (write)	15		ns	
	T _{CSH}	Chip select hold time (write)	15		ns	
CSX	Tcss	Chip select setup time (read)	60		ns	
	Tscc	Chip select hold time (read)	60		ns	
	T _{CHW}	Chip select "H" pulse width	40		ns	
	Tscycw	Serial clock cycle (Write)	66		ns	
	T _{SHW}	SCL "H" pulse width (Write)	15		ns	
001	T _{SLW}	SCL "L" pulse width (Write)	15		ns	
SCL	Tscycr	Serial clock cycle (Read)	150		ns	
	T _{SHR}	SCL "H" pulse width (Read)	60		ns	
	T _{SLR}	SCL "L" pulse width (Read)	60		ns	
SDA	T _{SDS}	Data setup time	10		ns	
(DIN)	T _{SDH}	Data hold time	10		ns	
SDO	T _{ACC}	Access time	20	50	ns	Max: CL=30pF
(DOUT)	Тон	Output disable time	50	50	ns	Min: CL=8pF

Note : The rising time and falling time (Tr, Tf) of input signal are specified at 15 ns or less. Logic high and low levels are specified as 30% and 70% of VDDI for Input signals.

Serial16 bitinterface write mode



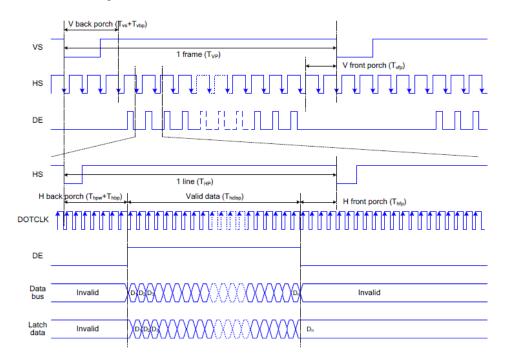
18bit RGB Interface Characteristics



Signal	Symbol	Parameter	MIN	MAX	Unit	Description
HSYNC, VSYNC	Tsyncs	VSYNC, HSYNC Setup Time	5	-	ns	
ENABLE	T _{ENS}	Enable Setup Time	5	-	ns	
ENABLE T _{ENH}		Enable Hold Time	5	-	ns	
	PWDH	DOTCLK High-level Pulse Width	15	-	ns	
PWDL		DOTCLK Low-level Pulse Width	15	-	ns	
DOTCLK Toyon	Тсуср	DOTCLK Cycle Time	33	-	ns	
Trghr, Trgh		DOTCLK Rise/Fall time	-	15	ns	
DB	T _{PDS}	PD Data Setup Time	5	-	ns	
DB	T _{PDH}	PD Data Hold Time	5	-	ns	

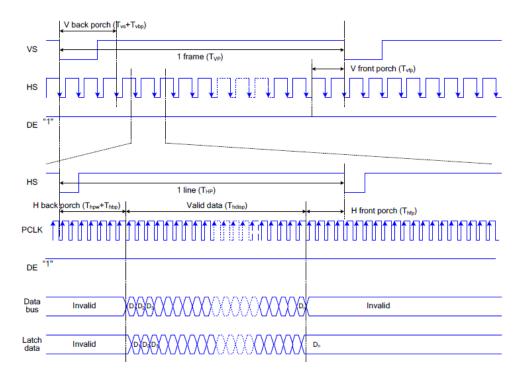
3.2.1 RGB Interface Timing

The timing chart of RGB interface DE mode is shown as follows.



Note: The setting of front porch and back porch in host must match that in IC as this mode

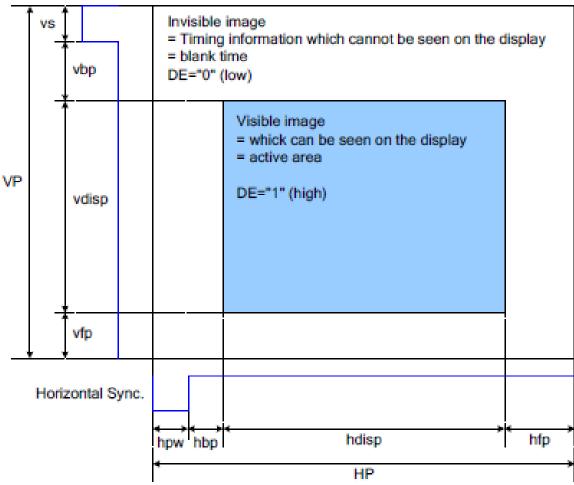




3.2.1 RGB Interface Definition

The display operation via the RGB interface is synchronized with the VSYNC, HSYNC, and DOTCLK signals. The data can be written only within the specified area with low power consumption by using window address function. The back porch and front porch are used to set the RGB interface timing.





Please refer to the following table for the setting limitation of RGB interface signals.

Parameter	Symbol	Min.	Тур.	Max.	Unit
Horizontal Sync. Width	hpw	2	-	255 (Note 2)	Clock
Horizontal Sync. Back Porch	hbp	2		255 (Note 2)	Clock
Horizontal Sync. Front Porch	hfp	2		-	Clock
Vertical Sync. Width	VS	2	-	254 (Note 2)	Line
Vertical Sync. Back Porch	vbp	2	-	254 (Note 2)	Line
Vertical Sync. Front Porch	vfp	2	-	-	Line

Note:

- 1. Typical value are related to the setting frame rate is 60Hz.
- VS+VBP<=254, HPW+HBP<=255

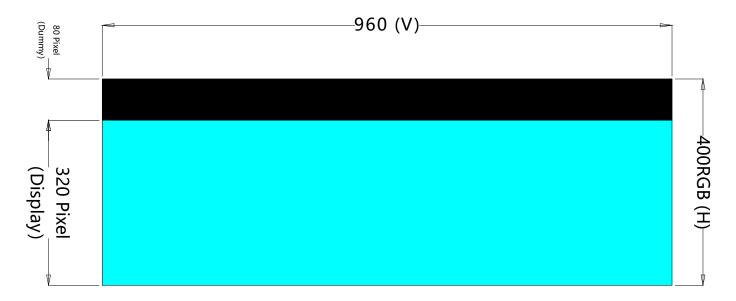
3.2.2 Recommended reference parameter Settings

Parameters	Symbol	Min.	Тур.	Max.	Unit	Remark
DCLK Frequency	FPCLK	-	25	-	MHz	
Horizontal Synchronization	Hsync	-	8	-	PCLK	
Horizontal Back Porch	HBP	-	2	-	PCLK	
Horizontal Front Porch	HFP	-	2	-	PCLK	
Hsync+HBP+HFP	-	-	12	-	PCLK	
Horizontal Address (Display area)	Hadr	-	400	-	PCLK	
Vertical Synchronization	Vsync	-	8	-	Line	
Vertical Back Porch	VBP	-	2	-	Line	
Vertical Front Porch	VFP	-	16	-	Line	
Vsync+VBP+VFP	-	-	26	-	Line	
Horizontal Address (Display area)	Vadr	-	960	-	Line	

Note: These parameter Settings are recommended, or users can set their own according to the timing table;

3.2.3 The picture transfer instructions

As you can see below, the image transfer on this 4.58-inch display is set to 400x960,



4.0 OPTICAL SPECIFICATIONS

Item	Symbol	Condition	Values			Unit	Remark
item	Syllibol	Min.		Тур.	Max.	Onit	Remark
	θ_{L}	Φ=180°(9 O'CLOCK)	70	80			Note 1
Viewing Angle	θ_{R}	Φ=0°(3 O'CLOCK)	70	80		dograo	
(CR≥10)	θτ	Φ=90°(12 O'CLOCK)	70	80		degree	
	θ_{B}	Φ=270°(6 O'CLOCK)	70	80			
Response Time	T _{ON +} T _{OFF}			25	35	msec	Note 3
Contrast Ratio	CR		800	1000			Note 4
	W _X	Normal	0.26	0.29	0.36		Note 2
Color Chromaticity	W_Y	Θ=Φ=0°	0.28	0.30	0.38		Note 5
	VVY	<u>0</u> -Ψ-0	0.20	0.50	0.30		Note 6
Luminance	L		400	450		cd/m ²	Note 6
Luminance Uniformity	Luminance Uniformity YU		75	80		%	Note 7

Test Conditions:

Note 1: Definition of viewing angle range

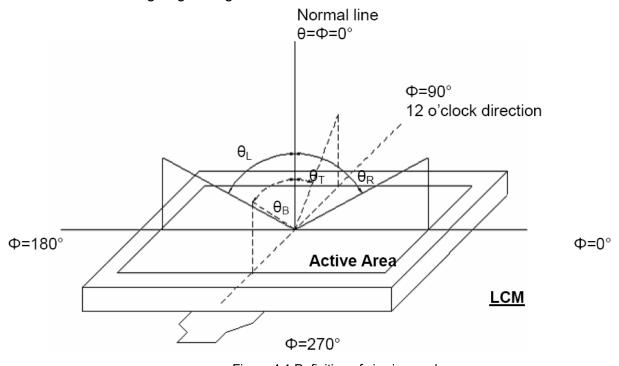


Figure 4.1 Definition of viewing angle.

Note 2: Definition of optical measurement system.

The optical characteristics should be measured in dark room. After 30 minutes operation, the optical properties are measured at the center point of the LCD screen. (Response time is measured by Photo detector TOPCON

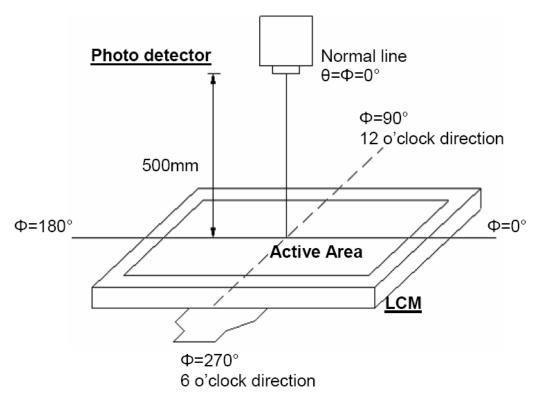


Figure 4.2 Optical measurement system setup

Note 3: Definition of Response time

The response time is defined as the LCD optical switching time interval between "White" state and "Black" state. Rise time (TON) is the time between photo detector output intensity changed from 90% to 10%. And fall time (TOFF) is the time between photo detector output intensity changed from 10% to 90%.

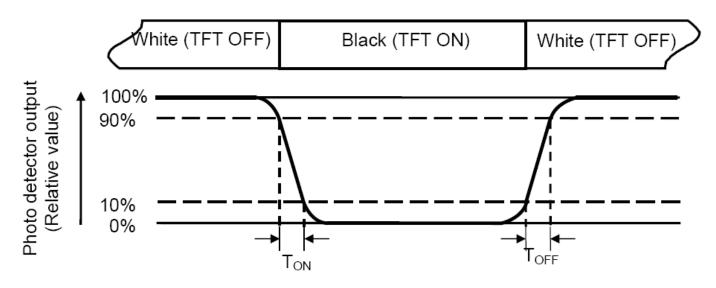


Figure 4.3 Definition of response.

Note 4: Definition of contrast ratio

 $\text{Contrast ratio(CR)} = \frac{\text{Luminance measured when LCD on the "white" state}}{\text{Luminance measured when LCD on the "black" state}}$

Note 5: Definition of color chromaticity (CIE1931)

Color coordinates measured at center point of LCD.

Note 6: All input terminals LCD panel must be ground while measuring the center area of the panel.

Note 7: Definition of Luminance Uniformity

Active area is divided into 9 measuring areas (Refer to Fig. 4.4). Every measuring point is placed at the center of each measuring area.

Luminance Uniformity (Yu) =
$$\frac{B_{min}}{B_{max}}$$

L-----Active area length W----- Active area width

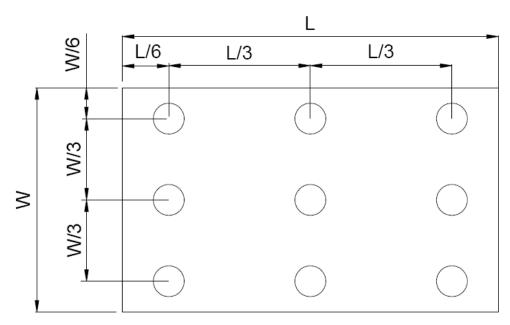


Figure 4.4 Definition of measuring points.

Bmax: The measured maximum luminance of all measurement position. Bmin: The measured minimum luminance of all measurement position.

5. RELIABILITY TEST

Item	Test Condition Item	Remark
High temperature storage	Ta= 80 °C 240hrs	Note 1 Note 4
Low temperature storage	Ta=-30 °C 240hrs	Note 1 Note 4
High temperature operation	Ts= 70 °C 240hrs	Note 2 Note 4
Low temperature operation	Ts=-20 °C 240hrs	Note 1 Note 4
High temperature/High humidity operation	90% RH 60°C 240hrs	Note 4
Thermal Shock	-30℃/30 min ~ +70℃/30 min for a total 100 cycles, Start with cold temperature and end with high temperature.	Note 4
Vibration test	Freq:10~55~10Hz Amplitude:1.5mm 2 hours for each direction of X,Y,Z (6 hours for total)	
Mechanical shock	100G 6ms,±X, ±Y, ±Z 3 times for each direction	
Package vibration test	Random Vibration: 0.015G*G/Hz from 5-200HZ, -6dB/Octave from 200-500HZ 2 hours for each direction of X. Y. Z. (6 hours for total)	
Package drop test	Height: 60 cm 1 corner, 3 edges, 6 surfaces	
Electro static discharge	R: 330 Ω C:150pF Contact discharge: ±2K	Note 5

- Note 1: Ta is the ambient temperature of samples.
- Note 2: Ts is the temperature of panel's surface.
- **Note 3**: In the standard condition, there shall be no practical problem that may affect the display function. After the reliability test, the product only guarantees operation, but don't guarantee all of the cosmetic specification.
- **Note 4**: Before cosmetic and function test, the product must have enough recovery time, at least 2 hours at room temperature.
- **Note 5:** Sample quantity no less than 3 pcs. Discharge no less than 5 times.
 - Contact discharge on bezel. For those without bezel, this test is not applicable
 - If the LCM is working abnormally during test but can recover after reset or after 2 hours recovery, the LCM is considered OK.

6. PRECAUTION FOR USING LCM

- When design the product with this LCD Module, make sure the viewing angle matches to its purpose of usage.
- 2. As LCD panel is made of glass substrate, dropping the LCD module or banging it against hard objects may cause cracking or fragmentation. Especially at corners and edges.
- 3. Although the polarizer of this LCD Module has the anti-glare coating, always be careful not to scratch its surface. Use of a plastic cover is recommended to protect the surface of polarizer.
- 4. If the LCD module is stored below specified temperature, the LC material may freeze and be deteriorated. If it is stored above specified temperature, the molecular orientation of the LC material may change to Liquid state and it may not revert to its original state. And also excessive temperature and humidity could cause polarizer peel off or bubble. Therefore, the LCD module should always be stored within specified temperature and humidity range. If the LCD modules will be stored for a long time, the recommend temperature/humidity for the storage environment is:

Temperature : 15°C ~ 35°C / Relatively humidity: ≤80%

- 5. Meanwhile please follow other requirements below for storage:
 - -Store with no touch on display surface by the anything else. If possible, store the LCD in the packaging situation when it was delivered.
- -If the original package is opened, please store in an anti-static polyethylene bag and seal it so as not to get fresh air outside enter into it.
 - LCD modules shall be stored in a dark place. And it shall not be exposed to sunlight nor fluorescent light in storage.

Note: If the storage time is over 1 year, the golden fingers of FPC might be slightly oxidized, but it won't affect the electrical performance, customer can use rubber to clean the golden fingers before assembly or directly assemble the display.

6. Saliva or water droplets must be wiped off immediately as those may leave stains or cause color changes if is remained there for a long time. And water vapor will cause corrosion of ITO electrodes.

If the surface of LCD panel needs to be cleaned, wipe it swiftly with cotton or other soft dry cloth. If it is not still clean enough, blow a breath on the surface and wipe again.

If needed, please just moisten cloth with one of the following solvents:

- Isopropyl alcohol
- Ethyl alcohol

Solvents other than those mentioned above may damage the polarizer. Especially, do not use the following:

- Water
- Ketone
- Aromatic solvents
- 7. The module should be driven according to the specified ratings to avoid malfunction and permanent damage. Applying DC voltage cause a rapid deterioration of LC material. Make sure to apply alternating waveform by continuous application of the M signal. Especially the power ON/OFF sequence should be kept to avoid latch-up of driver LSIs and DC charge up to LCD panel.
- 8. Mechanical Considerations
 - a) LCM are assembled and adjusted with a high degree of precision. Avoid excessive shocks and do not make any alterations or modifications. The following should be noted.
 - b) Do not tamper in any way with the tabs on the metal frame.
 - Do not modify the PCB by drilling extra holes, changing its outline, moving its components or modifying its pattern.
- 9. Static Electricity
 - a) Operator

Wear the electrostatics shielded clothes because human body may be statically charged if not ware shielded clothes. Never touch any of the conductive parts such as the LSI pads; the copper leads on the PCB and the interface terminals with any parts of the human body.

b) Equipment

There is a possibility that the static electricity is charged to the equipment, which has a function of peeling or friction action (ex: conveyer, soldering iron, working table). Earth the equipment through proper resistance (electrostatic earth: 1x10⁸ ohm).

Only properly grounded soldering irons should be used.

If an electric screwdriver is used, it should be well grounded and shielded from commutator sparks.

The normal static prevention measures should be observed for work clothes and working benches; for the latter conductive (rubber) mat is recommended.

c) Floor

Floor is the important part to drain static electricity, which is generated by operators or equipment.

There is a possibility that charged static electricity is not properly drained in case of insulating floor. Set the electrostatic earth (electrostatic earth: 1x10⁸ ohm).

d) Humidity

Proper humidity helps in reducing the chance of generating electrostatic charges. Humidity should be kept between 50%RH and 80%RH.

e) Transportation/storage

The storage materials also need to be anti-static treated because there is a possibility that the human body or storage materials such as containers may be statically charged by friction or peeling.

The modules should be kept in antistatic bags or other containers resistant to static for storage.

f) Soldering

Soldering anything to this TFT display would void the warranty.

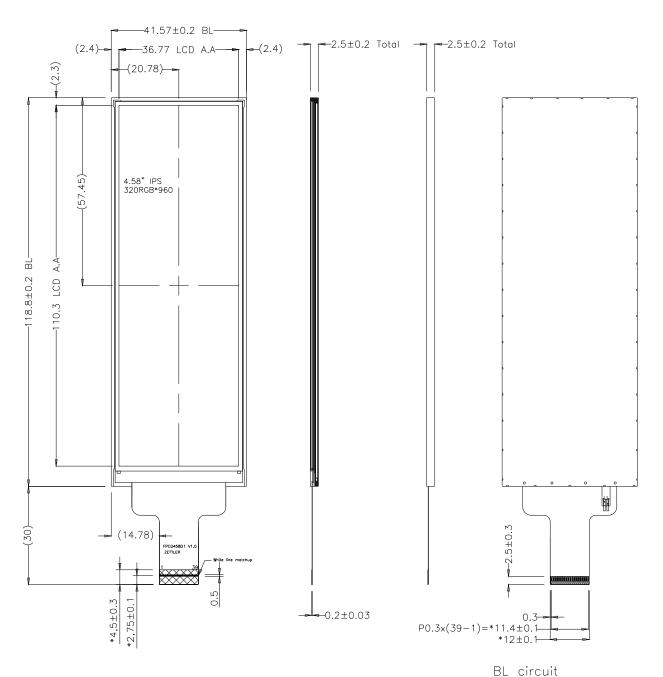
g) Others

The laminator (protective film) is attached on the surface of LCD panel to prevent it from scratches or stains. It should be peeled off slowly using static eliminator.

Static eliminator should also be installed to the workbench to prevent LCD module from static charge.

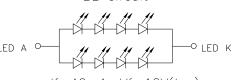
- 10. Operation
 - h) Driving voltage should be kept within specified range; excess voltage shortens display life.
 - i) Response time increases with decrease in temperature.
 - j) Display may turn black or dark blue at temperatures above its operational range; this is (however not pressing on the viewing area) may cause the segments to appear "fractured".
 - k) Mechanical disturbance during operation (such as pressing on the viewing area) may cause the segments to appear "fractured".
- 11. If any fluid leaks out of a damaged glass cell, wash off any human part that comes into contact with soap and water. The toxicity is extremely low but caution should be exercised at all the time.
- 12. Disassembling the LCD module can cause permanent damage and it should be strictly avoided.
- 13. LCD retains the display pattern when it is applied for long time (Image retention). To prevent image retention, do not apply the fixed pattern for a long time. Image retention is not a deterioration of LCD. It will be removed after display pattern is changed.
- 14. Do not use any materials, which emit gas from epoxy resin (hardener for amine) and silicone adhesive agent (dealcohol or deoxym) to prevent discoloration of polarizer due to gas.
- 15. Avoid the exposure of the module to the direct sunlight or strong ultraviolet light for a long time.

7. MECHANICAL DRAWING



NOTE:

- 1. Unspecified tolerance: ±0.3mm
- 2. "()"is reference dimension
- 3. Must meet the requirement of ROHS and REACH



If = 40 mA; Vf = 12 V(typ)

8. PACKAGE DRAWING

T.B.D

9. INSPECTION SPECIFICATION

1.SCOPE SPECIFICATIONS CONTAIN

- 1.1 DISPLAY QUALITY EVALUATION
- 1.2 MECHANICS SPECIFICATION

2.SAMPLING PLAN

UNLESS THERE IS OTHER AGREEMENT, THE SAMPLING PLAN FOR INCOMING INSPECTION SHALL FOLLOW MIL-STD-105E.

- 2.1 LOT SIZE: QUANTITY PER SHIPMENT AS ONE LOT (DIFFERENT MODEL AS DIFFERENT LOT).
- 2.2 SAMPLING TYPE: NORMAL INSPECTION, SINGLE SAMPLING.
- 2.3 SAMPLING LEVEL: LEVEL II.
- 2.4 AQL: ACCEPTABLE QUALITY LEVEL

MAJOR DEFECT: AQL=0.65 MINOR DEFECT: AQL=1.0

3.PANEL INSPECTION CONDITION

3.1 ENVIRONMENT:

ROOM TEMPERATURE: 25±5°C.

HUMIDITY: 65±5% RH.

ILLUMINATION: 300 ~ 700 LUX.

3.2 INSPECTION DISTANCE:

35±5 CM

3.3 INSPECTION ANGLE:

THE VISION OF INSPECTOR SHOULD BE PERPENDICULAR TO THE SURFACE OF THE MODULE.

3.4 INSPECTION TIME:

PERCEPTIBILITY TEST TIME: 20 SECONDS MAX.

4. DISPLAY QUALITY

4.1 FUNCTION RELATED:

THE FUNCTION DEFECTS OF LINE DEFECT, ABNORMAL DISPLAY, AND NO DISPLAY ARE CONSIDERED MAJOR DEFECTS.

4.2 BRIGHT/DARK DOTS:

Defect Type	Specification	Major	Minor
Bright Dots	N≦2		•
Drak Dots	N≦3		•
Total Bright and Dark Dots	N≦4		•

Note: 1:

The definition of dot: The size of a defective dot over 1/2 of whole dot is regarded as one defective dot.

Bright dot: Dots appear bright and unchanged in size in which LCD panel is displaying under black pattern.

The bright dot defect must be visible through 2% ND filter

Dark dot: Dots appear dark and unchanged in size in which LCD panel is displaying under pure red, green, blue pattern.

4.3 Pixel Definition:

R	G	В	R	G	В	R	G	В	Dot Defect
R	G	В	R	G	В	R	G	В	Adjacent Dot Defect
R	G		R	G	В	R	G	В	Cluster

Note 1:

If pixel or partial sub-pixel defects exceed 50% of the affected pixel or sub-pixel area, it shall be considered as1 defect.

Note 2:

There should be no distinct non-uniformity visible through 2% ND Filter within 2 sec inspection times.

4.4Visual Inspection specifications:

<u>D</u>	efect Type	Specification Size	Count (N)	Major	Minor
	Dot shape	D≤0.25mm			
	cratch and Bubbles in splay area)	0.25mm <d≤0.5mm< td=""><td>N≤3</td><td></td><td>•</td></d≤0.5mm<>	N≤3		•
		D>0.5mm	N=0		
N (D:	(O C T D	D≤70mm	N≤4		_
Newton Ring	(Only for Touch panel)	D>70mm	N=0		•
TOD Fink Free	· (Out of a Tarret man all	0.1mm <d≤0.2mm n≤4<="" td=""><td></td></d≤0.2mm>			
_	s (Only for Touch panel) ubble/Dent)	0.2mm <d≤0.3mm< td=""><td>N≤3</td><td></td><td>•</td></d≤0.3mm<>	N≤3		•
()	ubble/Defit)	0.3mm <d≤0.4mm< td=""><td>N≤2</td><td></td><td></td></d≤0.4mm<>	N≤2		
Line shape (Particles、Scratch、Lint and Bubbles in display area)		W≤0.01mm	Ignored		
		0.01 mm $<$ W \leqslant 0.05mm $,\;$ and L \leqslant 3mm	N≤3		•
		W $>$ 0.05mm, or L $>$ 3mm	N=0		
Bubble ir	n cell (active area)	It should be found by eyes		•	
	Scratch	No harm		•	
Bezel	Dirt	No harm		•	
Dezei	Wrap	No harm		•	
	Sunken	No harm		•	
	No label	No		•	
	Inverted label	No		•	
	Broken	No		•	
Label	Dirt	Word can be read		•	
Labei	Not clear	No			•
	Word out of shape	No		•	
	Mistake	No			•
	Position	Be attached on right position		•	
Screw	Not enough	No		•	
	Limp	No		•	
Connector	Connection status	No bend on PINs and damage			•
FPC/FFC Broken No					•

Note: Extraneous substance and scratch not affecting the display of image, for instance, extraneous substance under polarizer film but outside the display area, or scratch on metal bezel and backlight module or polarizer film outside the display area, shall not be considered as defective or non-conforming.